

### **General Description**

The MAX4249-MAX4257 low-noise, low-distortion operational amplifiers offer rail-to-rail outputs and singlesupply operation down to 2.4V. They draw 400µA of quiescent supply current per amplifier while featuring ultra-low distortion (0.0002% THD), as well as low input voltage-noise density (7.9nV/√Hz) and low input current-noise density (0.5fA/VHz). These features make the devices an ideal choice for portable/battery-powered applications that require low distortion and/or low noise.

For additional power conservation, the MAX4249/ MAX4251/MAX4253/MAX4256 offer a low-power shutdown mode that reduces supply current to 0.5µA and puts the amplifiers' outputs into a high-impedance state. The MAX4249-MAX4257's outputs swing rail-torail and their input common-mode voltage range includes ground. The MAX4250-MAX4254 are unitygain stable with a gain-bandwidth product of 3MHz. The MAX4249/MAX4255/MAX4256/MAX4257 are internally compensated for gains of 10V/V or greater with a gain-bandwidth product of 22MHz. The single MAX4250/ MAX4255 are available in space-saving 5-pin SOT23 packages. The MAX4252 is available in an 8-bump chipscale package (UCSPTM) and the MAX4253 is available in a 10-bump UCSP. The MAX4250AAUK comes in a 5-pin SOT23 package and is specified for operation over the automotive (-40°C to +125°C) temperature range.

### **Applications**

Wireless Communications Devices PA Control Portable/Battery-Powered Equipment Medical Instrumentation **ADC Buffers** 

Digital Scales/Strain Gauges

#### **Features**

- ♦ Available in Space-Saving UCSP, SOT23, and μMAX® Packages
- ♦ Low Distortion: 0.0002% THD (1kΩ load)
- ♦ 400µA Quiescent Supply Current per Amplifier
- Single-Supply Operation from 2.4V to 5.5V
- ♦ Input Common-Mode Voltage Range Includes Ground
- ♦ Outputs Swing Within 8mV of Rails with a 10kΩ Load
- ♦ 3MHz GBW Product, Unity-Gain Stable (MAX4250-MAX4254)

22MHz GBW Product, Stable with Ay ≥ 10V/V (MAX4249/MAX4255/MAX4256/MAX4257)

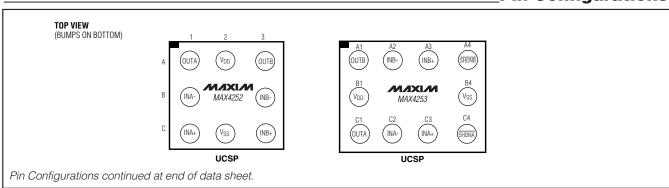
- **♦ Excellent DC Characteristics**  $Vos = 70\mu V$  $I_{BIAS} = 1pA$ Large-Signal Voltage Gain = 116dB
- **♦ Low-Power Shutdown Mode** Reduces Supply Current to 0.5µA Places Outputs in a High-Impedance State
- **♦** 400pF Capacitive-Load Handling Capability

### Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK	
MAX4249ESD	-40°C to +85°C	14 SO	_	
MAX4249EUB	-40°C to +85°C	10 μMAX	_	
MAX4250EUK-T	-40°C to +85°C	5 SOT23-5	ACCI	
MAX4250AAUK-T	-40°C to +125°C	5 SOT23-5	AEYJ	

Ordering Information continued at end of data sheet. Selector Guide appears at end of data sheet.

## Pin Configurations



UCSP is a trademark and µMAX is a registered trademark of Maxim Integrated Products, Inc.

MIXIM

Maxim Integrated Products 1

#### **ABSOLUTE MAXIMUM RATINGS**

Power-Supply Voltage ( $V_{DD}$ to $V_{SS}$ )+6.0V to -0.3V Analog Input Voltage ( $IN_+$ , $IN$ )( $V_{DD}$ + 0.3V) to ( $V_{SS}$ - 0.3V) SHDN Input Voltage6.0V to ( $V_{SS}$ - 0.3V) Output Short-Circuit Duration to Either SupplyContinuous
Continuous Power Dissipation ( $T_A = +70^{\circ}$ C)
5-Pin SOT23 (derate 7.1mW/°C above +70°C)571mW
8-Bump UCSP (derate 4.7mW/°C above +70°C)379mW
8-Pin µMAX (derate 4.5mW/°C above +70°C)362mW 8-Pin SO (derate 5.88mW/°C above +70°C)471mW
10-Bump UCSP (derate 6.1mW/°C above +70 °C)484mW

10 DiaMAY /-l	7000) 44414
10-Pin μMAX (derate 5.6mW/°C above	: +70°C)444mvv
14-Pin SO (derate 8.33mW/°C above 4	+70°C)667mW
Operating Temperature Range	40°C to +85°C
MAX4250AAUK	40°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Bump Temperature (soldering) (Note 1)	
Infrared (15s)	+220°C
Vapor Phase (60s)	+215°C

Note 1: This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile the device can be exposed to during board-level solder attach and rework. This limit permits only the use of the solder profiles recommended in the industry-standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and Convection Reflow. Preheating is required. Hand or wave soldering is not allowed.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = 0, V_{OUT} = V_{DD}/2, R_L \text{ tied to } V_{DD}/2, \overline{SHDN} = V_{DD}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.) \text{ (Notes 2, 3)}$ 

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS		
Supply Voltage Range	V <sub>DD</sub>	(Note 4)		2.4		5.5	V		
			$V_{DD} = 3V$			400			
		Normal		E temperature		420	575		
Quiescent Supply Current Per	IQ	mode	$V_{DD} = 5V$	MAX4250AAUK			675	μΑ	
Amplifier			$V_{DD} = 5V$ ,	UCSP only		420	655		
		Shutdow	n mode (SH	DN = V <sub>SS</sub> ) (Note 2)		0.5	1.5		
	1/	Vos E temperature MAX4250AAUK				±0.07	±0.75	>/	
Input Offset Voltage (Note 5)	VOS						±1.85	mV	
Input Offset Voltage Tempco	TCV <sub>OS</sub>					0.3		μV/°C	
Input Dice Current	1-	- (Nata C)		E temperature		±1	±100	рА	
Input Bias Current	IB	(Note 6)	MAX4250AAUK				±10	nA	
Input Offcot Current	laa	(Nlota 6)	E temp	erature		±1	±100	рΑ	
Input Offset Current	los	(Note 6)	MAX42	50AAUK			±10	nA	
Differential Input Resistance	R <sub>IN</sub>					1000		$G\Omega$	
Input Common-Mode Voltage		Guarante	eed by	E temperature	-0.2		V <sub>DD</sub> -1.1		
Range	V <sub>CM</sub>	CMRR te	est	MAX4250AAUK	0		V <sub>DD</sub> -1.1	V	
O-mana Marka Daiartian Dati	M		.V ≤ V <sub>CM</sub> ≤	E temperature	70	115		-ID	
Common-Mode Rejection Ratio	CMRR	V <sub>DD</sub> - 1.1	IV	MAX4250AAUK	68			dB	
Power Supply Pointion Potio	PSRR	Vpp = 0	1\/ to 5 5\/	E temperature	75	100		dD	
Power-Supply Rejection Ratio	FORK	$V_{DD} = 2.4V \text{ to } 5.5V$		MAX4250AAUK	72			dB	

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = 0, V_{OUT} = V_{DD}/2, R_L \text{ tied to } V_{DD}/2, \overline{SHDN} = V_{DD}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $T_A = +25$ °C.) (Notes 2, 3)

PARAMETER	SYMBOL	CONDIT	TONS		MIN	TYP	MAX	UNITS
		$R_L = 10k\Omega$ to $V_{DD}/2$ ;	E temperati	ure	80	116		
Large Cianal Valtage Cain	Δ	$V_{OUT} = 25$ mV to $V_{DD}$ - 4.97V	MAX4250A.	MAX4250AAUK				-ID
Large-Signal Voltage Gain	Av	$R_L = 1k\Omega$ to $V_{DD}/2$ ;	E temperati	ure	80	112		dB
		$V_{OUT} = 150V \text{ to } V_{DD} - 4.75V$	MAX4250A.	AUK	77			
			V <sub>DD</sub> - V <sub>OH</sub>	E		8	25	
Output Voltage Swing	Vout	$ V_{IN+} - V_{IN-}  \ge 10 \text{mV};$ $ R_I  = 10 \text{k} \Omega \text{ to } V_{DD}/2$		A E		7	30 20	mV
			V <sub>OL</sub> - V <sub>SS</sub>	А		<u> </u>	25	
			V <sub>DD</sub> - V <sub>OH</sub>	Е		77	200	
Output Voltage Swing	$V_{OUT}$ $ V_{IN+} - V_{IN-}  \ge 10 \text{mV},$	VDD - VOH	А			225	mV	
		$R_L = 1k\Omega$ to $V_{DD}/2$	V <sub>OL</sub> - V <sub>SS</sub>	E A		47	100	
Output Short-Circuit Current	Isc			A		68	125	mA
Output Leakage Current	ILEAK		Shutdown mode (SHDN = Vss), Vout = Vss to Vpp (Note 2)			0.001	1.0	μΑ
SHDN Logic Low	V <sub>IL</sub>	(Note 2)					0.2 x V <sub>DD</sub>	V
SHDN Logic High	VIH	(Note 2)			0.8 X V <sub>DD</sub>			V
SHDN Input Current	IIL/IIH	SHDN = V <sub>SS</sub> = V <sub>DD</sub> (N	ote 2)			0.5	1.5	μΑ
Input Capacitance						11		рF
Online Description of the Description	ODW	MAX4250-MAX4254				3		MI I-
Gain-Bandwidth Product	GBW	MAX4249/MAX4255/MAX4256/MAX4257				22		MHz
	0.0	MAX4250-MAX4254				0.3		\//
Slew Rate	SR	MAX4249/MAX4255/MAX4256/MAX4257			2.1		V/µs	
Peak-to-Peak Input-Noise Voltage	e <sub>nP-P</sub>	f = 0.1Hz to 10Hz				760		nV <sub>P-P</sub>
		f = 10Hz				27		
Input Voltage-Noise Density	en	f = 1kHz				8.9		nV/√Hz
		f = 30kHz				7.9		(4/11
Input Current-Noise Density	in	f = 1kHz				0.5		fA/√Hz

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = 0, V_{OUT} = V_{DD}/2, R_L \text{ tied to } V_{DD}/2, \overline{SHDN} = V_{DD}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.) \text{ (Notes 2, 3)}$ 

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Total Harmonic Distortion Plus		MAX4250-MAX42 A <sub>V</sub> = 1V/V, V <sub>OUT</sub>		f = 1kHz		0.0004		
	THD+N	$R_L = 1k\Omega$ to GND (Note 7)		f = 20kHz		0.006		%
Noise	I IIID+N	MAX4249/MAX42 MAX4256/MAX42	•	f = 1kHz		0.0012		%
		$A_V = 1V/V, V_{OUT} = 1k\Omega$ to GND		f = 20kHz		0.007		
Capacitive-Load Stability		No sustained osc	illations			400		рF
Gain Margin		MAX4250-MAX4254, A <sub>V</sub> = 1V/V			10			
	GM	MAX4249/MAX42 A <sub>V</sub> = 10V/V	MAX4249/MAX4255/MAX4256/MAX4257, A <sub>V</sub> = 10V/V			12.5		dB
		MAX4250-MAX4254, A <sub>V</sub> = 1V/V			74			
Phase Margin	ΦМ	MAX4249/MAX4255/MAX4256/MAX4257, A <sub>V</sub> = 10V/V		68		Degrees		
		T- 0.010/ Volum	MAX425	0-MAX4254		6.7		
Settling Time		To 0.01%, Vout = 2V step		9/MAX4255/ 6/MAX4257		1.6		μs
		IVDD = 5% of	MAX4251/MAX4253			0.8		
Delay Time to Shutdown			normal operation MAX4249/MAX4256		1.2			μs
Delay Time to Enable	ten	VOUT = 2.5V, MAX42		1/MAX4253		8		μs
,		0.1%	MAX424	9/MAX4256		3.5		Į
Power-Up Delay Time	tpU	$V_{DD} = 0 \text{ to } 5V \text{ ste}$	VDD = 0 to 5V step, VOUT stable to 0.1%			6		μs

Note 2: SHDN is available on the MAX4249/MAX4251/MAX4253/MAX4256 only.

**Note 3:** All device specifications are 100% tested at  $T_A = +25^{\circ}C$ . Limits over temperature are guaranteed by design.

Note 4: Guaranteed by the PSRR test.

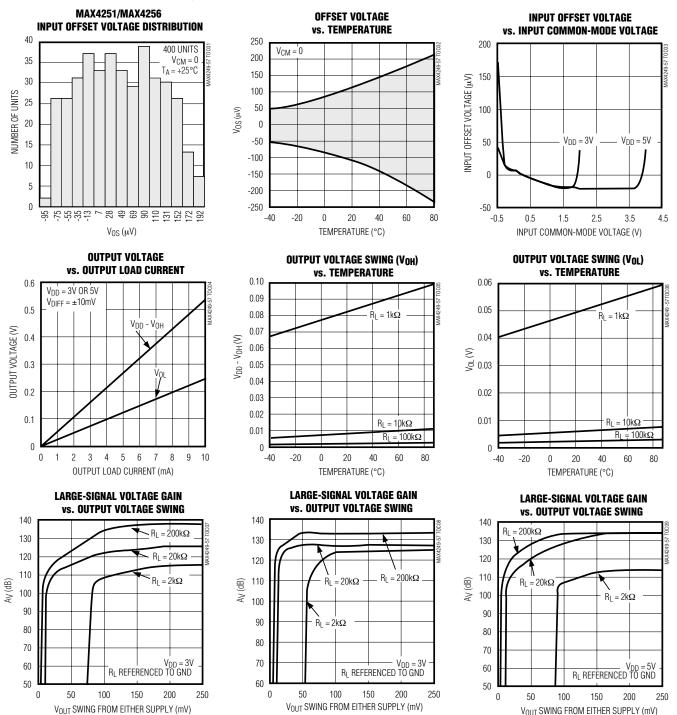
Note 5: Offset voltage prior to reflow on the UCSP.

Note 6: Guaranteed by design.

Note 7: Lowpass-filter bandwidth is 22kHz for f = 1kHz and 80kHz for f = 20kHz. Noise floor of test equipment = 10nV/√Hz.

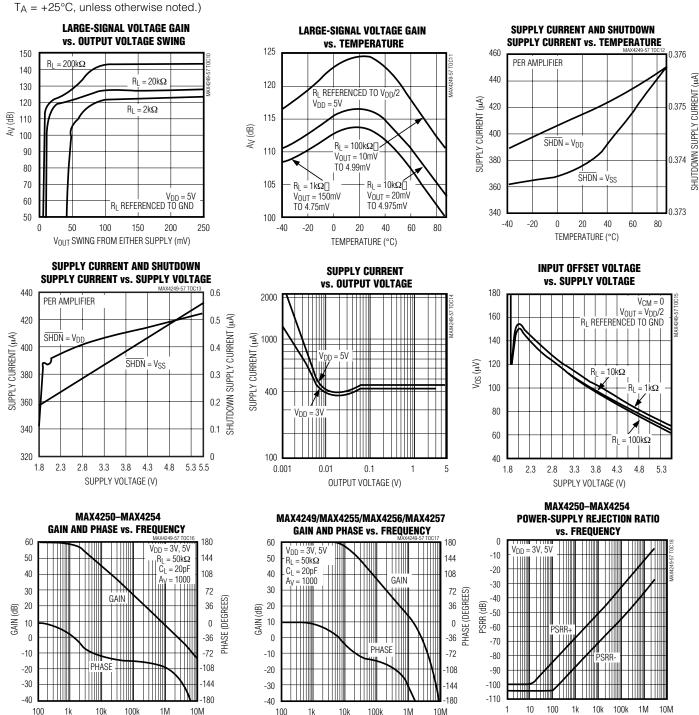
### Typical Operating Characteristics

 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = V_{OUT} = V_{DD}/2$ , input noise floor of test equipment =10nV/ $\sqrt{Hz}$  for all distortion measurements,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



### Typical Operating Characteristics (continued)

 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = V_{OUT} = V_{DD}/2$ , input noise floor of test equipment =  $10nV/\sqrt{Hz}$  for all distortion measurements,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



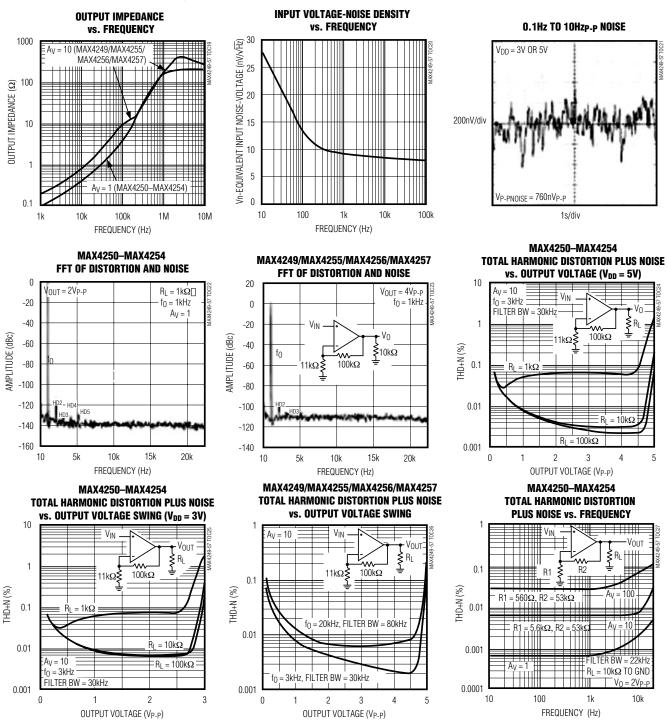
FREQUENCY (Hz)

FREQUENCY (Hz)

FREQUENCY (Hz)

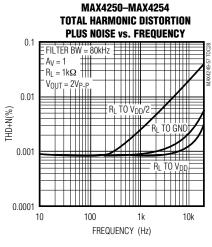
### Typical Operating Characteristics (continued)

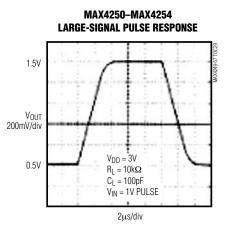
 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = V_{OUT} = V_{DD}/2$ , input noise floor of test equipment =10nV/ $\sqrt{Hz}$  for all distortion measurements,  $T_A = +25^{\circ}C$ , unless otherwise noted.)

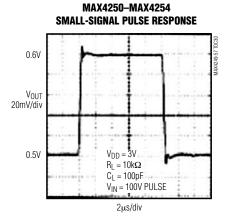


### Typical Operating Characteristics (continued)

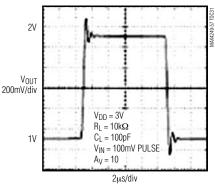
 $(V_{DD} = 5V, V_{SS} = 0, V_{CM} = V_{OUT} = V_{DD}/2$ , input noise floor of test equipment =10nV/ $\sqrt{Hz}$  for all distortion measurements,  $T_A = +25$ °C, unless otherwise noted.)

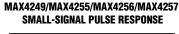


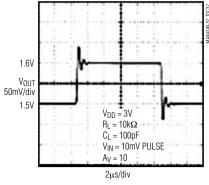


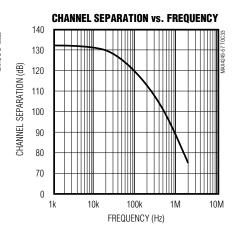


### MAX4249/MAX4255/MAX4256/MAX4257 Large-Signal Pulse Response









### **Pin Description**

			PIN/BUM	P					
MAX4250/ MAX4255	MAX4251/ MAX4256	MAX4252/ MAX4257	MAX4252		MAX4249/ MAX4253		MAX4254	NAME	FUNCTION
5-PIN SOT23	8-PIN SO/µMAX	8-PIN SO/µMAX	8-BUMP UCSP	10-BUMP UCSP	10-PIN μMAX	14-PIN SO	14-PIN SO		
1	6	1, 7	A1, A3	A1, C1	1, 9	1, 13	1, 7, 8, 14	OUT, OUTA, OUTB, OUTC, OUTD	Amplifier Output
2	4	4	C2	B4	4	4	11	V <sub>SS</sub>	Negative Supply. Connect to ground for single- supply operation
3	3	3, 5	C1, C3	A3, C3	3, 7	3, 11	3, 5, 10, 12	IN+, INA+, INB+, INC+, IND+	Noninverting Amplifier Input
4	2	2, 6	B1, B3	A2, C2	2, 8	2, 12	2, 6, 9, 13	IN-, INA-, INB-, INC-, IND-	Inverting Amplifier Input
5	7	8	A2	B1	10	14	4	$V_{DD}$	Positive Supply
_	8	_	-	A4, C4	5, 6	6, 9	_	SHDN, SHDNA, SHDNB	Shutdown Input, Connect to V <sub>DD</sub> or leave unconnected for normal operation (amplifier(s) enabled).
	1, 5	_	_	_	_	5, 7, 8, 10	_	N.C.	No Connection. Not internally connected.
_	_	_	B2	B2, B3	_	_	_	_	Not populated with solder sphere

### **Detailed Description**

The MAX4249–MAX4257 single-supply operational amplifiers feature ultra-low noise and distortion while consuming very little power. Their low distortion and low noise make them ideal for use as preamplifiers in wide dynamic-range applications, such as 16-bit analog-to-digital converters (see *Typical Operating Circuit*). Their high-input impedance and low noise are also useful for signal conditioning of high-impedance sources, such as piezoelectric transducers.

These devices have true rail-to-rail output operation, drive loads as low as  $1k\Omega$  while maintaining DC accura-

cy, and can drive capacitive loads up to 400pF without oscillation. The input common-mode voltage range extends from  $V_{DD}$  - 1.1V to 200mV beyond the negative rail. The push-pull output stage maintains excellent DC characteristics, while delivering up to  $\pm 5$ mA of current.

The MAX4250–4254 are unity-gain stable, whereas, the MAX4249/MAX4255/MAX4256/MAX4257 have a higher slew rate and are stable for gains ≥ 10V/V. The MAX4249/MAX4251/MAX4253/MAX4256 feature a low-power shutdown mode, which reduces the supply current to 0.5µA and disables the outputs.

The MAX4250AAUK is specified for operation over the automotive (-40°C to +125°C) temperature range.

#### **Low Distortion**

Many factors can affect the noise and distortion that the device contributes to the input signal. The following guidelines offer valuable information on the impact of design choices on Total Harmonic Distortion (THD).

Choosing proper feedback and gain resistor values for a particular application can be a very important factor in reducing THD. In general, the smaller the closed-loop gain, the smaller the THD generated, especially when driving heavy resistive loads. Large-value feedback resistors can significantly improve distortion. The THD of the part normally increases at approximately 20dB per decade, as a function of frequency. Operating the device near or above the full-power bandwidth significantly degrades distortion.

Referencing the load to either supply also improves the part's distortion performance, because only one of the MOSFETs of the push-pull output stage drives the output. Referencing the load to midsupply increases the part's distortion for a given load and feedback setting. (See the Total Harmonic Distortion vs. Frequency graph in the *Typical Operating Characteristics*.)

For gains ≥ 10V/V, the decompensated devices MAX4249/MAX4255/MAX4256/MAX4257 deliver the best distortion performance, since they have a higher slew rate and provide a higher amount of loop gain for a given closed-loop gain setting. Capacitive loads below 400pF, do not significantly affect distortion results. Distortion performance remains relatively constant over supply voltages.

#### Low Noise

The amplifier's input-referred, noise-voltage density is dominated by flicker noise at lower frequencies, and by thermal noise at higher frequencies. Because the thermal noise contribution is affected by the parallel combination of the feedback resistive network (RF II RG, Figure 1), these resistors should be reduced in cases where the system bandwidth is large and thermal noise is dominant. This noise contribution factor decreases, however, with increasing gain settings.

For example, the input noise-voltage density of the circuit with RF =  $100k\Omega$ , RG =  $11k\Omega$  (Av = 10V/V) is en = 15nV/VHz, en can be reduced to 9nV/VHz by choosing RF =  $10k\Omega$ , RG =  $1.1k\Omega$  (Av = 10V/V), at the expense of greater current consumption and potentially higher distortion. For a gain of 100V/V with RF =  $100k\Omega$ , RG =  $1.1k\Omega$ , the en is low (9nV/VHz).

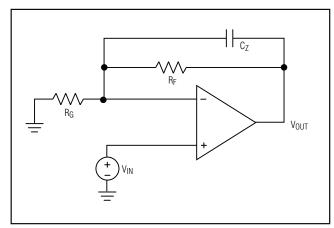


Figure 1. Adding Feed-Forward Compensation

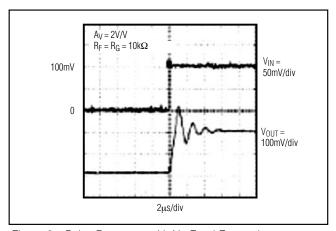


Figure 2a. Pulse Response with No Feed-Forward Compensation

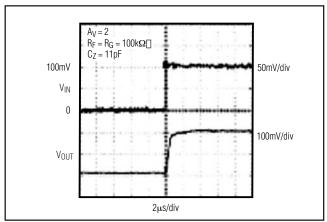


Figure 2b. Pulse Response with 10pF Feed-Forward Compensation

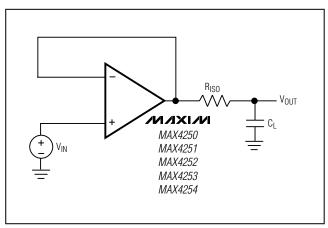


Figure 3. Overdriven Input Showing No Phase Reversal

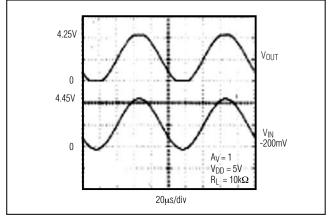


Figure 4. Rail-to-Rail Output Operation

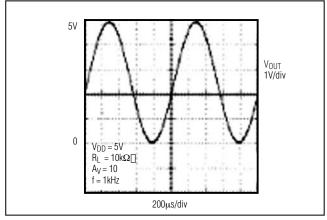


Figure 5. Capacitive-Load Driving Circuit

# Using a Feed-Forward Compensation Capacitor, Cz

The amplifier's input capacitance is 11pF. If the resistance seen by the inverting input is large (feedback network), this can introduce a pole within the amplifier's bandwidth, resulting in reduced phase margin. Compensate the reduced phase margin by introducing a feed-forward capacitor (C<sub>Z</sub>) between the inverting input and the output (Figure 1). This effectively cancels the pole from the inverting input of the amplifier. Choose the value of C<sub>Z</sub> as follows:

$$C_Z = 11 \times (R_F / R_G) [pF]$$

In the unity-gain stable MAX4250–MAX4254, the use of a proper Cz is most important for Ay = 2V/V, and Ay = -1V/V. In the decompensated MAX4249/MAX4255/MAX4256/MAX4257, Cz is most important for Ay = 10V/V. Figures 2a and 2b show transient response both with and without Cz.

Using a slightly smaller C<sub>Z</sub> than suggested by the formula above achieves a higher bandwidth at the expense of reduced phase and gain margin. As a general guideline, consider using C<sub>Z</sub> for cases where R<sub>G</sub> II R<sub>F</sub> is greater than 20k $\Omega$  (MAX4250–MAX4254) or greater than 5k $\Omega$  (MAX4249/MAX4255/MAX4256/MAX4257).

### Applications Information

The MAX4249–MAX4257 combine good driving capability with ground-sensing input and rail-to-rail output operation. With their low distortion, low noise, and low-power consumption, these devices are ideal for use in portable instrumentation systems and other low-power, noise-sensitive applications.

#### **Ground-Sensing and Rail-to-Rail Outputs**

The common-mode input range of these devices extends below ground, and offers excellent common-mode rejection. These devices are guaranteed not to undergo phase reversal when the input is overdriven (Figure 3).

Figure 4 showcases the true rail-to-rail output operation of the amplifier, configured with AV = 10V/V. The output swings to within 8mV of the supplies with a 10k $\Omega$  load, making the devices ideal in low-supply-voltage applications.

#### **Output Loading and Stability**

Even with their low quiescent current of 400 $\mu$ A, these amplifiers can drive 1k $\Omega$  loads while maintaining excellent DC accuracy. Stability while driving heavy capacitive loads is another key feature.

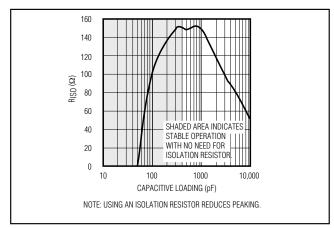


Figure 6. Isolation Resistance vs. Capacitive Loading to Minimize Peaking (<2dB)

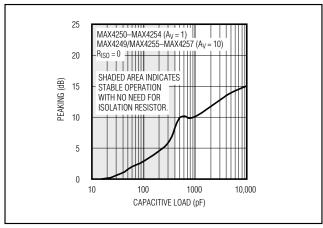


Figure 7. Peaking vs. Capacitive Load

These devices maintain stability while driving loads up to 400pF. To drive higher capacitive loads, place a small isolation resistor in series between the output of the amplifier and the capacitive load (Figure 5). This resistor improves the amplifier's phase margin by isolating the capacitor from the op amp's output. Reference Figure 6 to select a resistance value that will ensure a load capacitance that limits peaking to <2dB (25%).

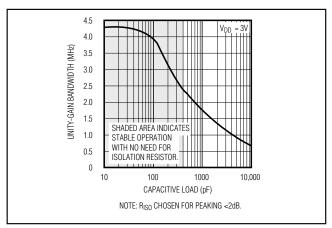


Figure 8. MAX4250–MAX4254 Unity-Gain Bandwidth vs. Capacitive Load

For example, if the capacitive load is 1000pF, the corresponding isolation resistor is  $150\Omega$ . Figure 7 shows that peaking occurs without the isolation resistor. Figure 8 shows the unity-gain bandwidth vs. capacitive load for the MAX4250–MAX4254.

#### **Power Supplies and Layout**

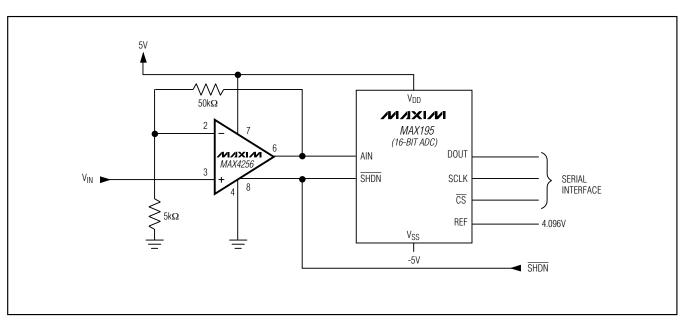
The MAX4249–MAX4257 operate from a single 2.4V to 5.5V power supply or from dual supplies of  $\pm 1.20$ V to  $\pm 2.75$ V. For single-supply operation, bypass the power supply with a  $0.1\mu F$  ceramic capacitor placed close to the V<sub>DD</sub> pin. If operating from dual supplies, bypass each supply to ground.

Good layout improves performance by decreasing the amount of stray capacitance and noise at the op amp's inputs and output. To decrease stray capacitance, minimize PC board trace lengths and resistor leads, and place external components close to the op amp's pins.

### \_UCSP Applications Information

For the latest application details on UCSP construction, dimensions, tape carrier information, PC board techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, refer to the Application Note: UCSP—A Wafer-Level Chip-Scale Package on Maxim's web site at www.maxim-ic.com/ucsp.

## Typical Operating Circuit



### **Selector Guide**

PART	GAIN BANDWIDTH (MHz)	MINIMUM STABLE GAIN (V/V)	NO. OF AMPLIFIERS PER PACKAGE	SHUTDOWN MODE	PIN-PACKAGE
MAX4249	22	10	2	Yes	10-pin μMAX, 14-pin SO
MAX4250/A	3	1	1	_	5-pin SOT23
MAX4251	3	1	1	Yes	8-pin μMAX/SO
MAX4252	3	1	2	_	8-pin μMAX/SO, 8-bump UCSP
MAX4253	3	1	2	Yes	10-pin μMAX, 14-pin SO, 10-bump UCSP
MAX4254	3	1	4	_	14-pin SO
MAX4255	22	10	1	_	5-pin SOT23
MAX4256	22	10	1	Yes	8-pin μMAX/SO
MAX4257	22	10	2	_	8-pin μMAX/SO

### Ordering Information (continued)

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX4251ESA	-40°C to +85°C	8 SO	_
MAX4251EUA	-40°C to +85°C	8 µMAX	_
MAX4252EBL-T	-40°C to +85°C	8 UCSP-8	AAO
MAX4252ESA	-40°C to +85°C	8 SO	_
MAX4252EUA	-40°C to +85°C	8 µMAX	_
MAX4253EBC-T	-40°C to +85°C	10 UCSP-10	AAK
MAX4253EUB	-40°C to +85°C	10 μMAX	_
MAX4253ESD	-40°C to +85°C	14 SO	_
MAX4254ESD	-40°C to +85°C	14 SO	_
MAX4255EUK-T	-40°C to +85°C	5 SOT23-5	ACCJ
MAX4256ESA	-40°C to +85°C	8 SO	_
MAX4256EUA	-40°C to +85°C	8 µMAX	_
MAX4257ESA	-40°C to +85°C	8 SO	_
MAX4257EUA	-40°C to +85°C	8 µMAX	_

### **Chip Information**

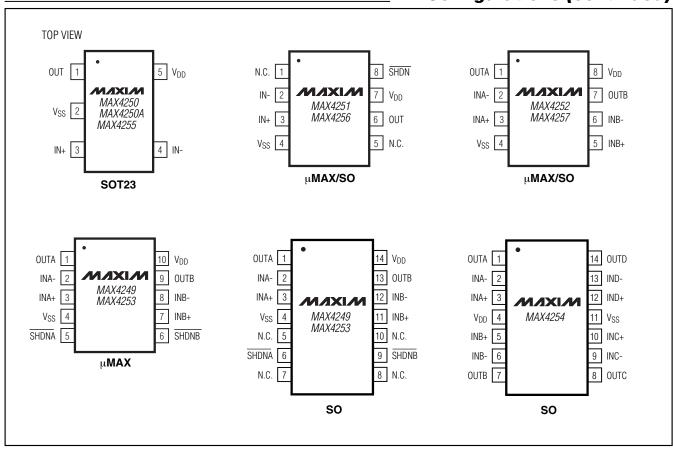
MAX4250/MAX4251/MAX4255/MAX4256 TRANSISTOR COUNT: 170

MAX4249/MAX4252/MAX4253/MAX4257 TRANSISTOR

COUNT: 340

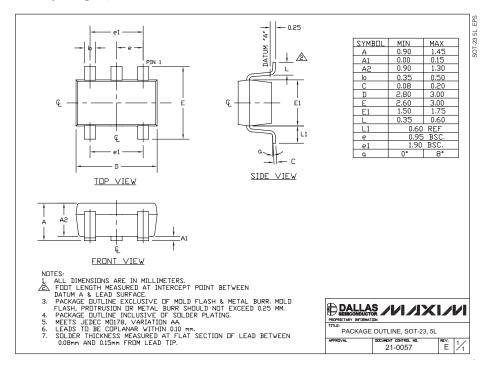
MAX4254 TRANSISTOR COUNT: 680

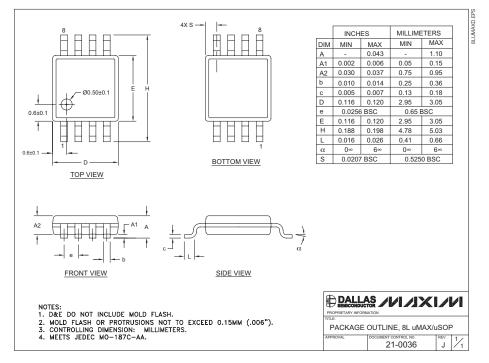
## Pin Configurations (continued)



### **Package Information**

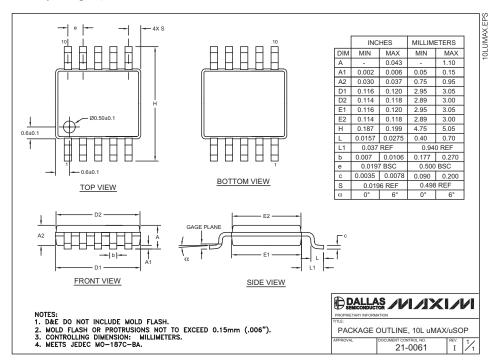
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)

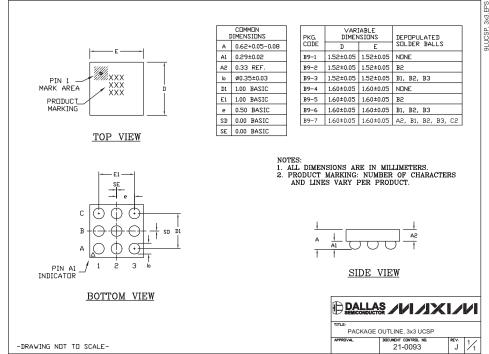




### **Package Information (continued)**

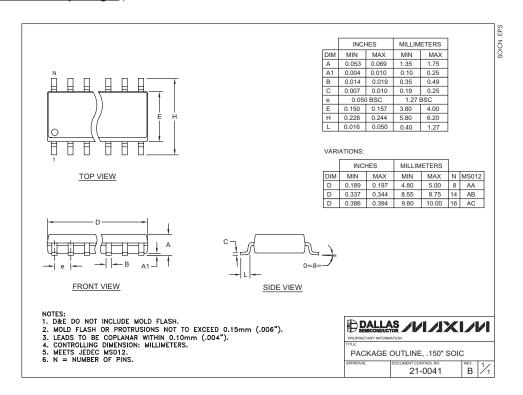
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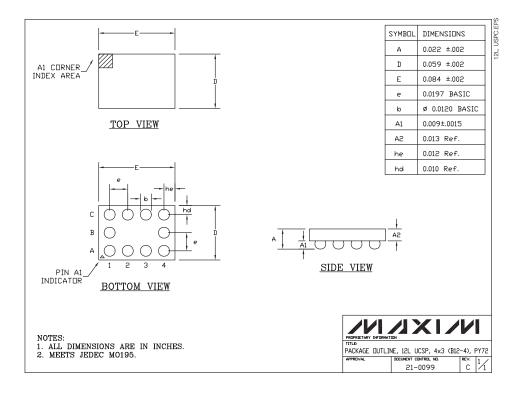
### Package Information (continued)

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### **Package Information (continued)**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



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